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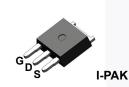
FCU900N60Z N-Channel SuperFET[®] II MOSFET 600 V, 4.5 A, 900 mΩ

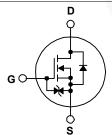
Features

- 675 V @ T_J = 150^oC
- Typ. R_{DS(on)} = 820 mΩ
- Ultra Low Gate Charge (Typ. Q_g = 13 nC)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 48.6 pF)
- 100% Avalanche Tested
- ESD Improved Capacity
- RoHS Compliant

Applications

- LCD / LED / PDP TV and Monitor Lighting
- Solar Inverter
- Charger





SuperFET[®] II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing

charge balance technology for outstanding low on-resistance

and lower gate charge performance. This technology is tailored

to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently,

SuperFET II MOSFET is very suitable for the switching power

applications such as PFC, server/telecom power, FPD TV

power, ATX power and industrial power applications.

Description

Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

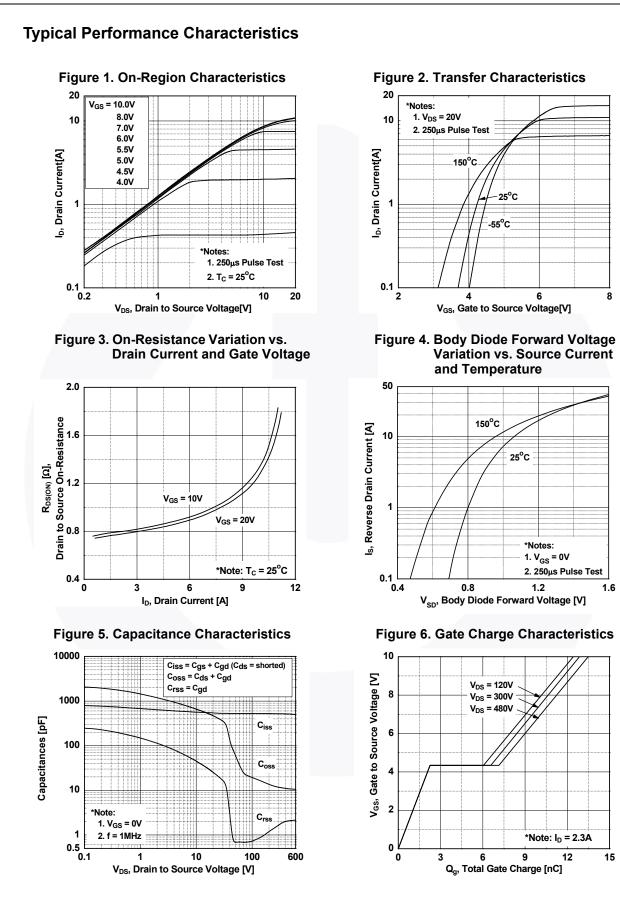
Symbol	Parameter			FCU900N60Z	Unit	
V _{DSS}	Drain to Source Voltage	Drain to Source Voltage		600	V	
V _{GSS}		- DC	- DC		V	
	Gate to Source Voltage	- AC	(f > 1 Hz)	±30	- V	
I _D	Drain Current	- Continuous (T _C = 25°C)		4.5		
	Drain Current	- Continuous (T _C = 100 ^o C)		2.8	Α	
I _{DM}	Drain Current	- Pulsed	(Note 1)	13.5	Α	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		47.5	mJ		
I _{AR}	Avalanche Current (Note 1)		1	Α		
E _{AR}	Repetitive Avalanche Energy (Note 1)		0.52	mJ		
dv/dt	MOSFET dv/dt			100	V/ns	
	Peak Diode Recovery dv/dt (Note 3)			20		
P _D	Dewer Dissingtion	(T _C = 25 ^o C)		52	W	
	Power Dissipation	- Derate Above 25°C		0.42	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		econds	300	°C	

Thermal Characteristics

Symbol	Parameter	FCU900N60Z	Unit	
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max. 2.4			
R_{\thetaJA}	Thermal Resistance, Junction to Ambient, Max.	100	°C/W	

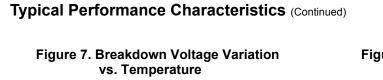
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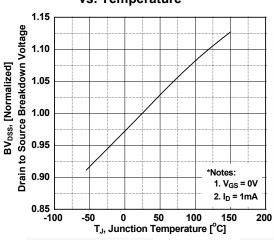
Fait Nu	-		Package	e Packing Method	Reel Size	Тар	e Width	Qua	ntity
FCU900			IPAK	Tube	N/A		N/A	70 units	
Electrica	al Chara	acteristics T _c = 25	°C unless o	otherwise noted.					
Symbol		Parameter		Test Condition	ons	Min.	Тур.	Max.	Uni
Off Chara	ctoristics						.,,		
	Drain to Source Breakdown Voltage		-	$I_{D} = 1 \text{ mA}, V_{GS} = 0 \text{ V}, T_{J} = 25^{\circ}\text{C}$ $I_{D} = 1 \text{ mA}, V_{GS} = 0 \text{ V}, T_{J} = 150^{\circ}\text{C}$		625	-	-	
BV _{DSS}			ge			675		-	V
ΔBV _{DSS} / ΔT _J		Breakdown Voltage Temperature Coefficient		$I_D = 1 \text{ mA}$, Referenced to 25° C		-	0.67	-	V/ºC
BV _{DS}	Drain to Voltage	Source Avalanche Break	down	V _{GS} = 0 V, I _D = 4.5 A		-	700	-	V
DSS		Zero Gate Voltage Drain Current		V _{DS} = 600 V, V _{GS} = 0 \		-	-	1	μA
.033				V _{DS} = 600 V, T _C = 125		-	-	10	μ
I _{GSS}	Gate to	Body Leakage Current		$V_{GS} = \pm 20 V, V_{DS} = 0 V$	/	-	-	±10	μA
On Charad	cteristics	5							
V _{GS(th)}	Gate Th	reshold Voltage		V _{GS} = V _{DS} , I _D = 250 μA	4	2.5	-	3.5	V
R _{DS(on)}	Static Dr	ain to Source On Resista	ance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 2.3 \text{ A}$		-	0.82	0.90	Ω
9 _{FS}	Forward	Transconductance		$V_{\rm DS} = 20 \text{ V}, \text{ I}_{\rm D} = 2.3 \text{ A}$		-	4.6	-	S
Dynamic (Characto	rietice							
C _{iss}		pacitance				-	534	710	pF
		Capacitance	-	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz			399	530	pF
C _{oss} C _{rss}		Transfer Capacitance					19.7	30	pF
C _{oss}		ut Capacitance		V _{DS} = 380 V, V _{GS} = 0 V, f = 1 MHz			11.1		pF
C _{oss(eff.)}		ve Output Capacitance		$V_{DS} = 360 \text{ V}, V_{GS} = 0 \text{ V}, 1 = 1 \text{ WHZ}$ $V_{DS} = 0 \text{ V} \text{ to } 480 \text{ V}, V_{GS} = 0 \text{ V}$		-	48.6		pF
		Gate Charge at 10V				-	13.1	17	nC
Q _{g(tot)} Q _{gs}		Source Gate Charge		V _{DS} = 380 V, I _D = 2.3 A, V _{GS} = 10 V		-	2.2	-	nC
Q _{gd}		to Drain "Miller" Charge		(Note 4)			4.5	-	nC
ESR		ivalent Series Resistance		f = 1 MHz			2.4	-	Ω
Duvitakina	Charact	a viation							-
Switching	-								
t _{d(on)}		Turn-On Delay Time		V_{DD} = 380 V, I _D = 2.3 A, V_{GS} = 10 V, R _G = 4.7 Ω		-	10.9	32	ns
t _r	Turn-On Rise Time					-	5.3	21	ns
t _{d(off)}		Delay Time		_ ~ ~ ~		-	33.6	77	ns
t _f	Turn-Off	Fall Time			(Note 4)	-	11.9	34	ns
Drain-Sou	rce Diod	e Characteristics							
I _S	Maximun	n Continuous Drain to So	urce Diode	de Forward Current		-	-	4.5	Α
I _{SM}	Maximun	n Pulsed Drain to Source	Diode For	orward Current		-		13.5	Α
V _{SD}	Drain to :	rain to Source Diode Forward Voltage		V _{GS} = 0 V, I _{SD} = 2.3 A		-		1.2	V
t _{rr}		erse Recovery Time		V _{GS} = 0 V, I _{SD} = 2.3 A,		-	156	-	ns
Q _{rr}	Reverse	Recovery Charge		dI _F /dt = 100 A/μs		-	1.3	-	μC



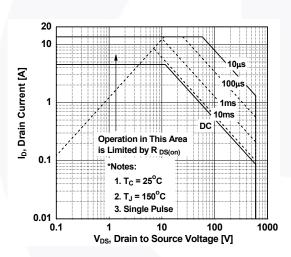
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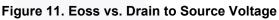


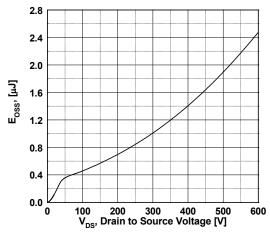


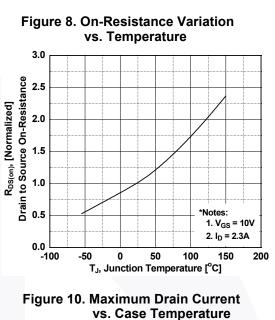


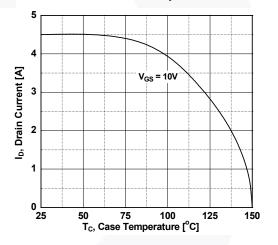


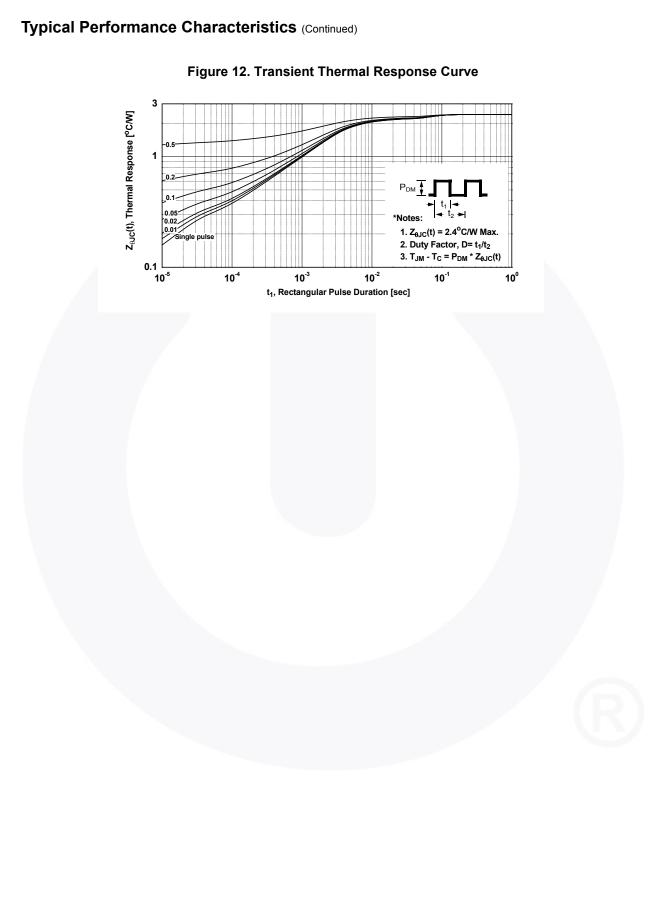


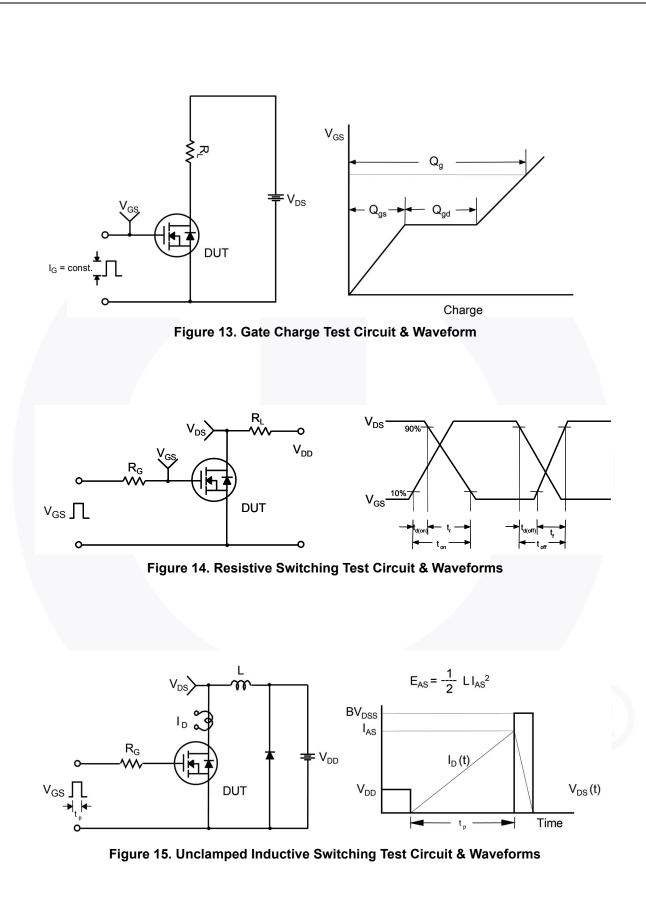




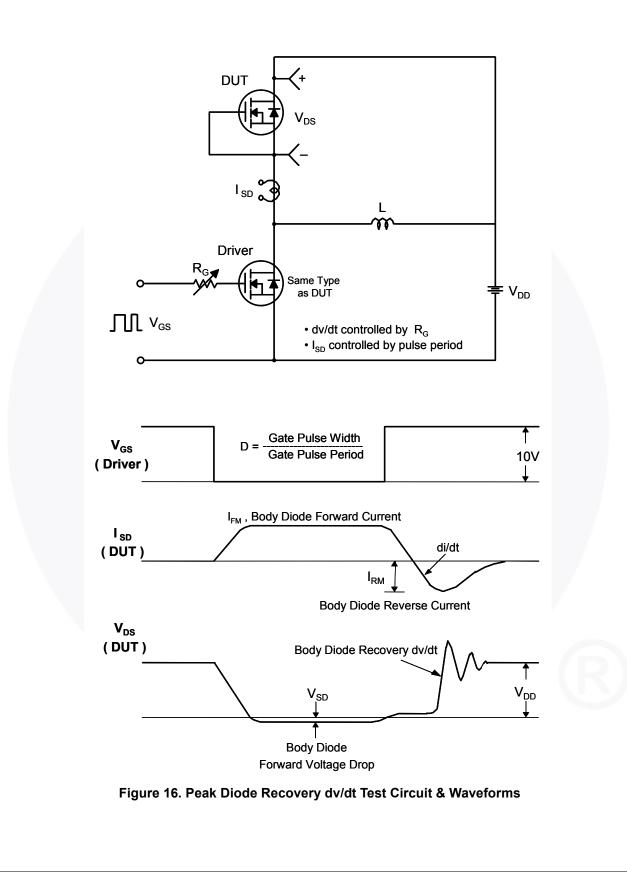


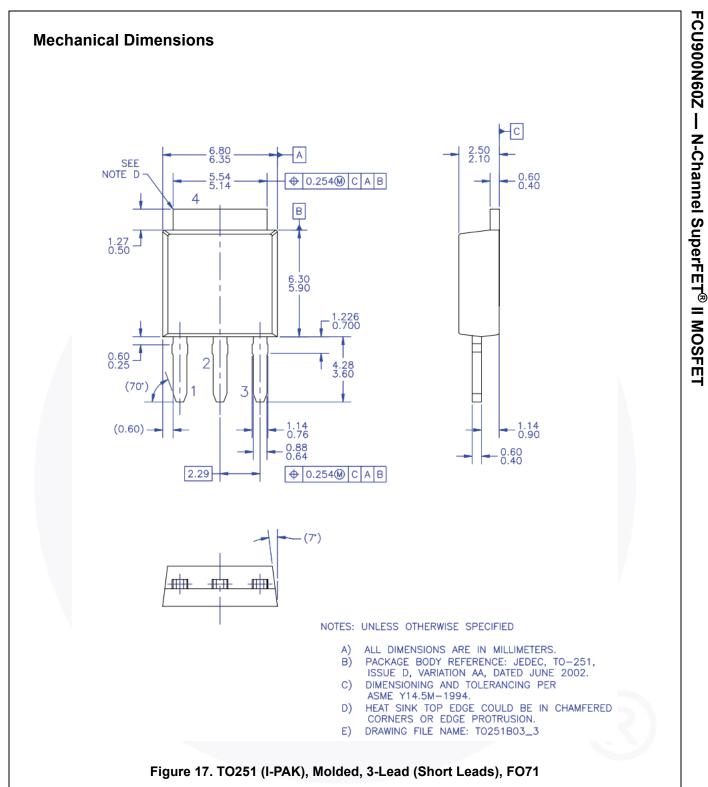






FCU900N60Z — N-Channel SuperFET[®] II MOSFET





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